RAYTAC 勁達國際電子有限公司
Raytac Corporation
www.raytac.com Tel: +886-2-3234-0208 Mail: service@raytac.com

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Approval Sheet

(產品承認書)

產品名稱 (Product): BT 5.0 Module (nRF52840)

產品型號 (Model No.): **MDBT50Q – 1M** (Chip Antenna)

MDBT50Q – P1M (PCB Antenna)

MDBT50Q – U1M (u.FL Antenna)

MDBT50Q (Chip Antenna)

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1. Overall Introduction

Raytac's MDBT50Q, MDBT50Q-1M, MDBT50Q-P1M and MDBT50Q-U1M is a BT 5.0 stack (Bluetooth low energy or BLE) module designed based on **Nordic nRF52840 SoC solution**, which incorporates: **GPIO**, **SPI**, **UART**, **I2C**, **I2S, PMD, PWM, ADC**, **NFC** and **USB** interfaces for connecting peripherals and sensors.

Features of the module:

1. Embedded 2.4GHz transceiver supports Bluetooth 5, IEEE 802.15.4 & 2.4Ghz RF & ANT upon customer's preference.
2. Compact size with **(L) 15.5 x (W) 10.5 x (H) 2.2 or 2.0 mm**.
3. Low power requirements, ultra-low peak, average and idle mode power consumption.
4. Be compatible with a large installed base of mobile phones, tablets and computers.
5. Fully coverage of BLE software stack.
6. BLE & RF transmission switching helps products fit all operation system and most hardware.

1.1. Application

- IoT Networks
  - Smart home (such as door locks, lighting) sensors and controllers
  - Smart city sensor networks
  - Industrial IoT sensors and controllers
  - Connected white goods
- Personal Area Networks
  - Health / fitness sensor and monitor device
  - Medical device
- Interactive entertainment devices
  - Advanced remote controls
  - Gaming controller
- Advanced wearables
  - Connected watches
  - Advanced personal fitness devices
  - Wearables with wireless secure payment
  - Connected Health
  - Virtual/Augmented Reality applications
- High performance HID Controllers

1.2. Features

- Bluetooth 5, IEEE 802.15.4, 2.4 GHz transceiver
    - -95dBm sensitivity in 1Mbps Bluetooth low energy (BLE) mode
    - -103dBm sensitivity in 125Kbps BLE mode (long range)
    - +8 dBm TX power (down to -20 dBm in 4 dB steps)
    - On-air compatible with nRF52, nRF51, nRF24L and nRF24AP Series
    - Programmable output power from +8dBm to -20dB
    - RSSI (1dB resolution)
    - Supported data rates:
        - Bluetooth 5: 2 Mbps, 1 Mbps, 500 kbps, 125 kbps
        - IEEE 802.15.4-2006: 250 kbps
        - Proprietary 2.4 GHz: 2 Mbps, 1 Mbps
- ARM Cortex –M4 32-bit processor with FPU, 64 MHz
- Memory: 1MB flash / 256KB RAM
- HW accelerated security
    - ARM TrustZone Cryptocell 310 cryptographic accelerator
    - 128 bit AES / ECB / CCM / AAR co-processor (on-the-fly packet encryption)
- Advanced on-chip interfaces
    - USB 2.0 full speed (12Mbps) controller
    - QSPI 32MHz interface
    - High speed 32MHz SPI
    - Type 2 near field communication (NFC-A) tag with wake-on field
    - Programmable peripheral interconnect (PPI)
    - 48 general purpose I/O pins
    - EasyDMA automated data transfer without CPU processing on peripherals
- 12 bit, 200ksps ADC – 8 configurable channels with programmable gain
- 4 x 4 channel pulse width modulator (PWM)units with EasyDMA
- Audio peripherals : I2S, digital microphone interface (PDM)
- 5 X 32-bit timers with counter mode
- Up to 4 x SPI masters / 3 x SPI slaves with EasyDMA
- Up to 2 x I2C compatible 2-wire masters / slaves
- 2 x UART(CTS/RTS) with EasyDMA
- Quadrature decoder (QDEC)
- 3 x 24-bit real-time counters (RTC)

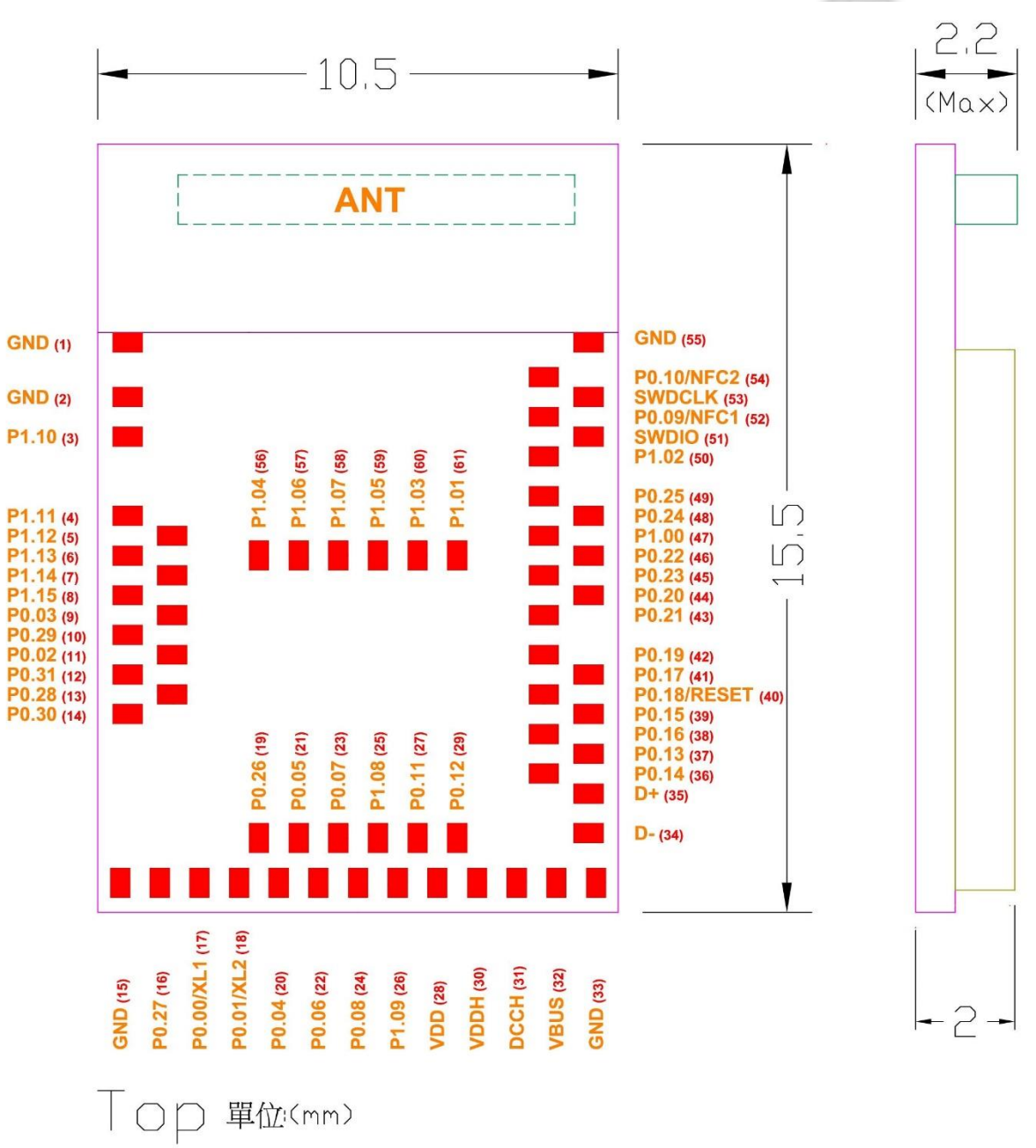
- Flexible power management
    - Supply voltage range 1.7V to 5.5V
    - On-chip DC/DC and LDO regulators with automated low current modes
    - Regulated supply for external components from 1.8V to 3.3V
    - Automated peripheral power management
    - Fast wake-up using 64MHz internal oscillator
    - 0.4uA at 3V in OFF mode, no RAM retention
    - 1.5uA at 3V in ON mode, no RAM retention, wake on RTC
- Nordic SoftDevice ready and with support for concurrent multi-protocol

2. Product Dimension

2.1. PCB Dimensions & Pin Indication

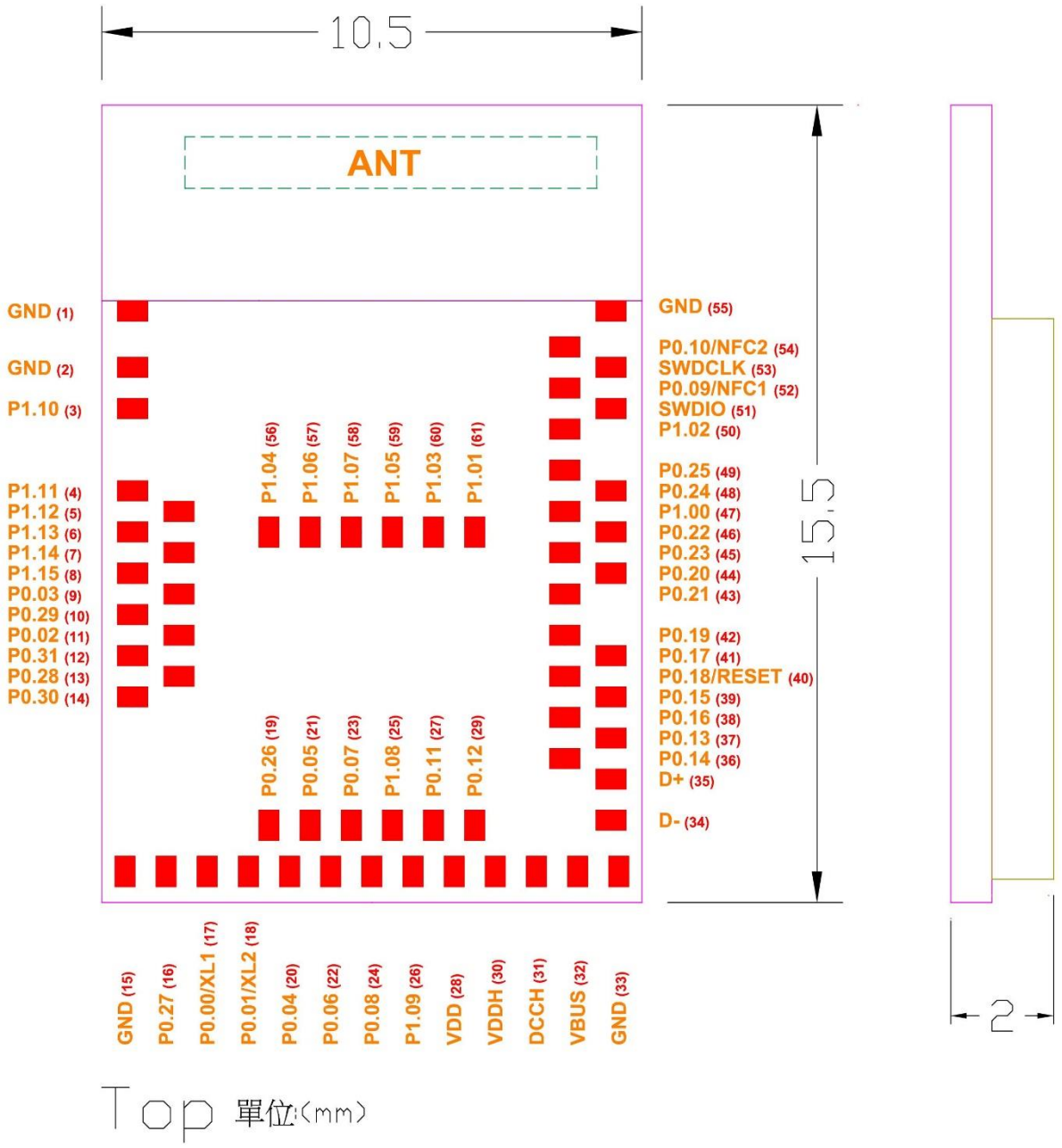
- **MDBT50Q & MDBT50Q-1M**

PCB SIZE: (L) 15.5 x (W) 10.5x (H) 2.2 mm



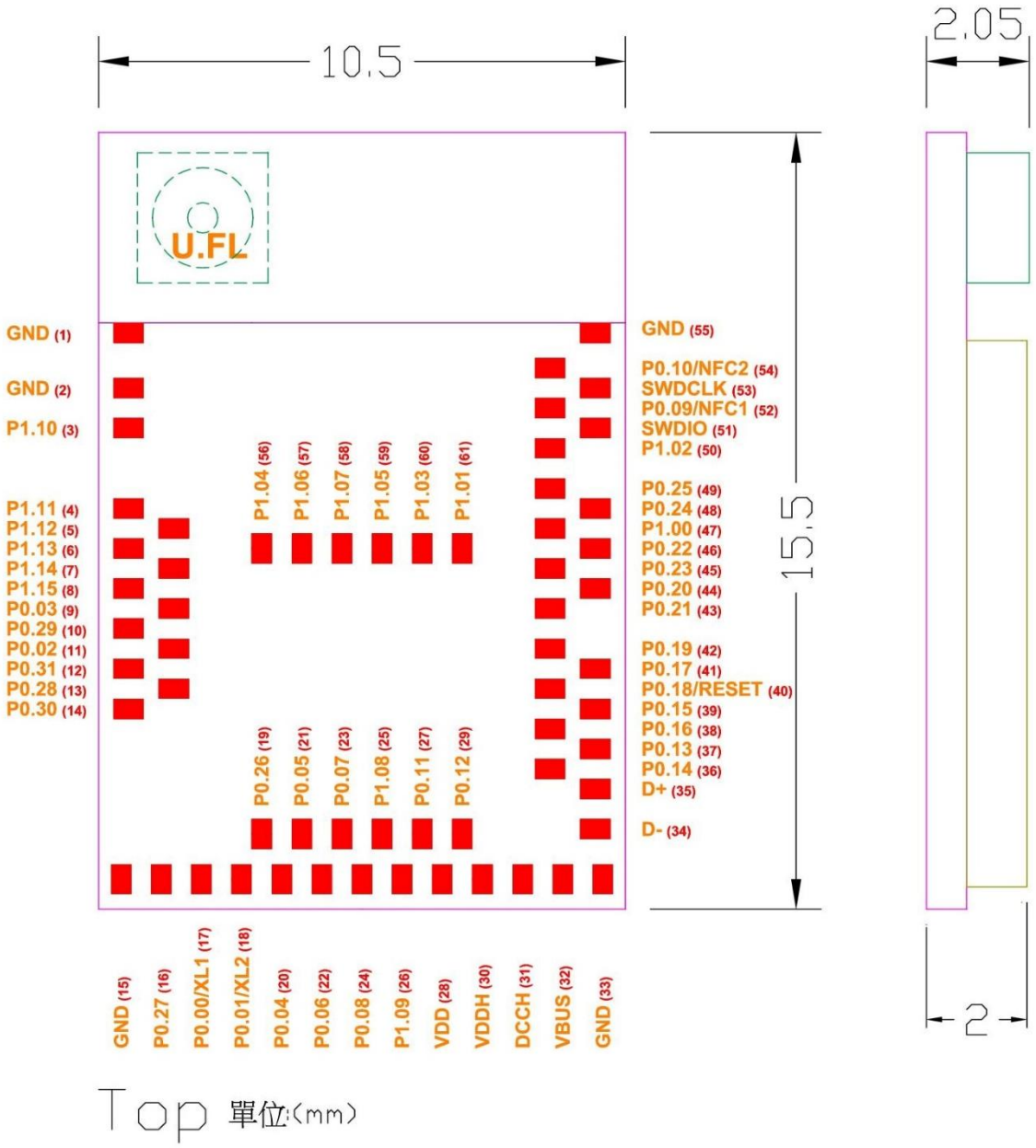
- **MDBT50Q-P1M**

PCB SIZE: (L) 15.5 x (W) 10.5 x (H) 2.0 mm



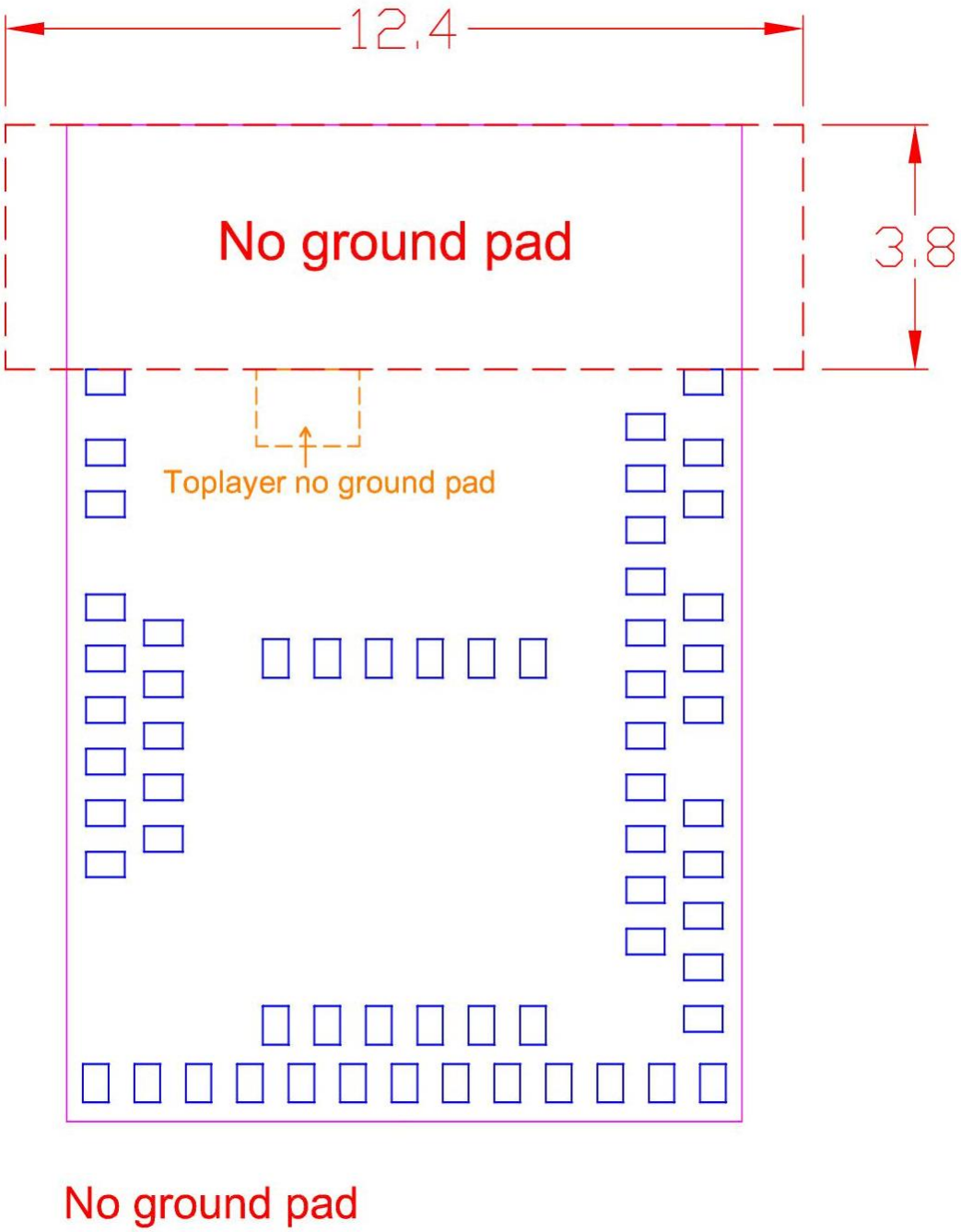
- **MDBT50Q-U1M**

PCB SIZE: (L) 15.5 x (W) 10.5x (H) 2.05 mm

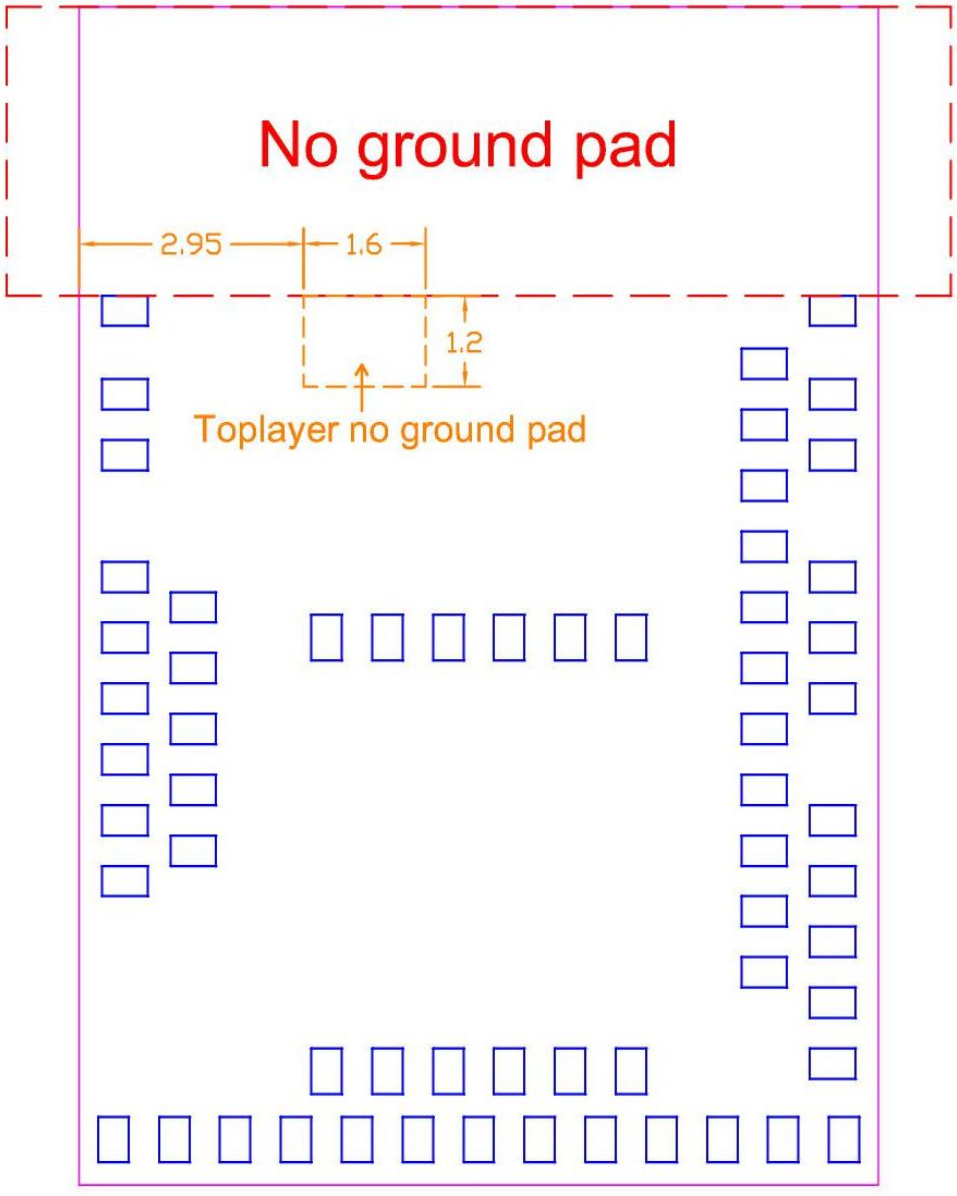


2.2. Recommended Layout of Solder Pad

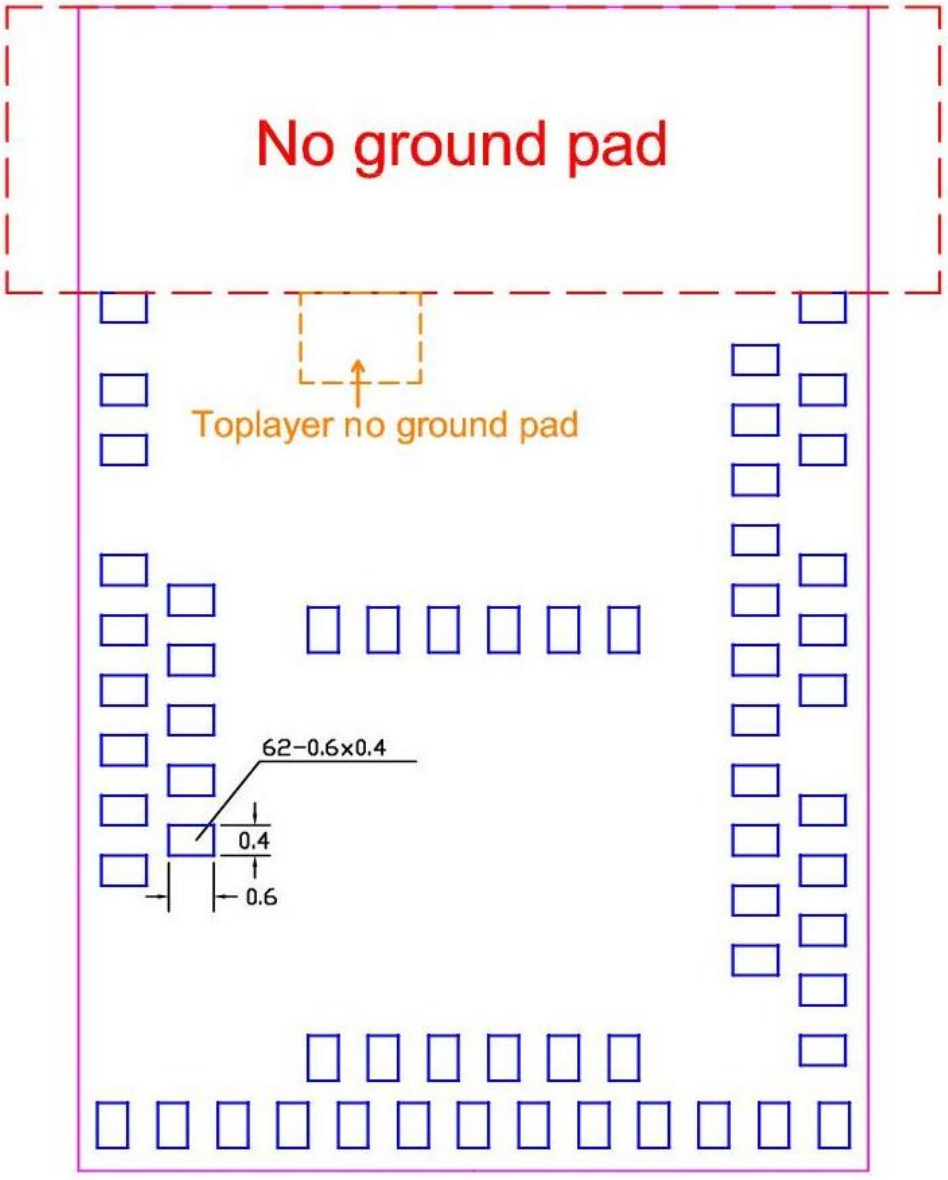
Graphs are all in Top View, Unit in mm.

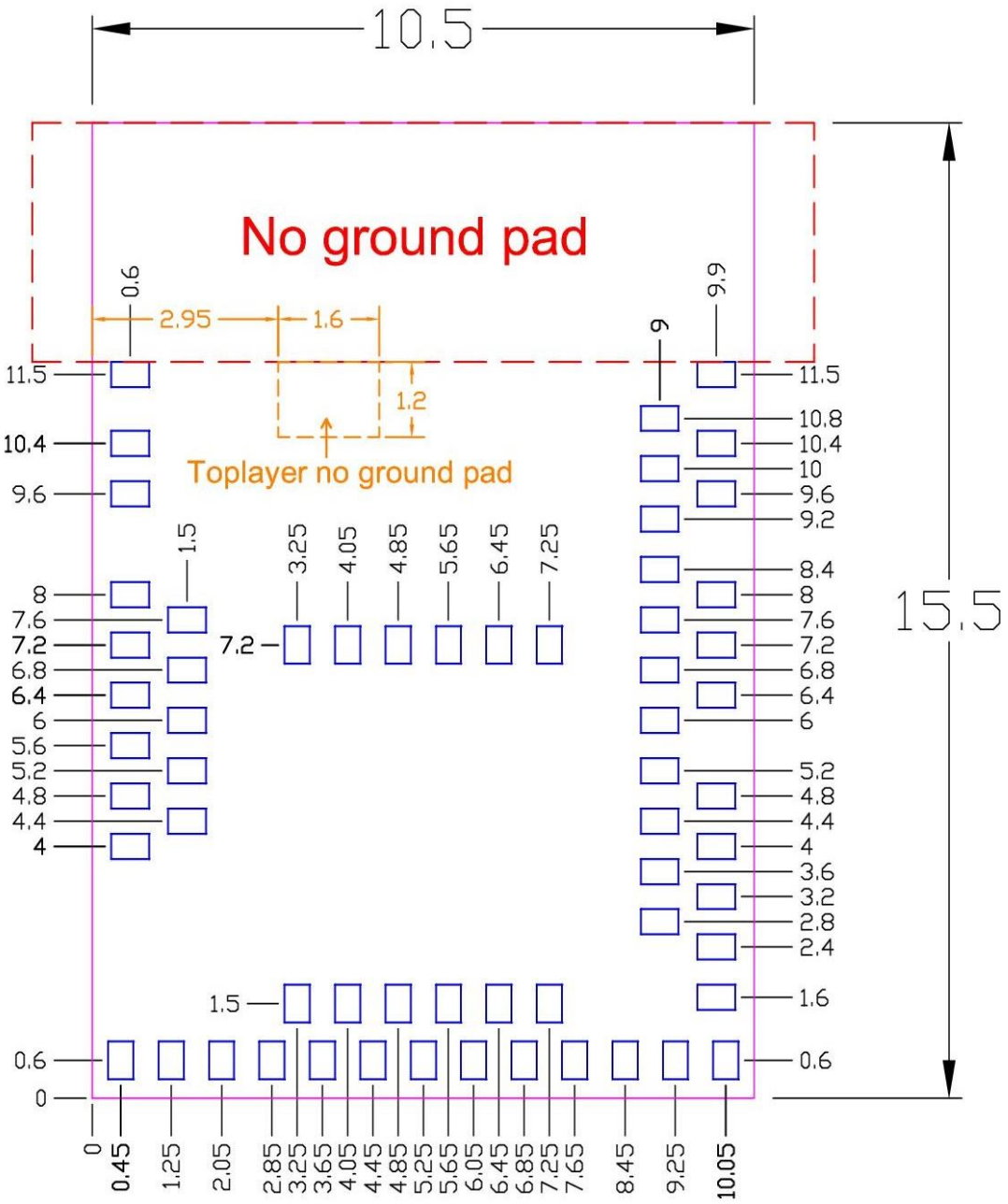


No ground pad



Toplayer no ground pad


No ground pad
Toplayer no ground pad
62-0.6x0.4
0.4
0.6



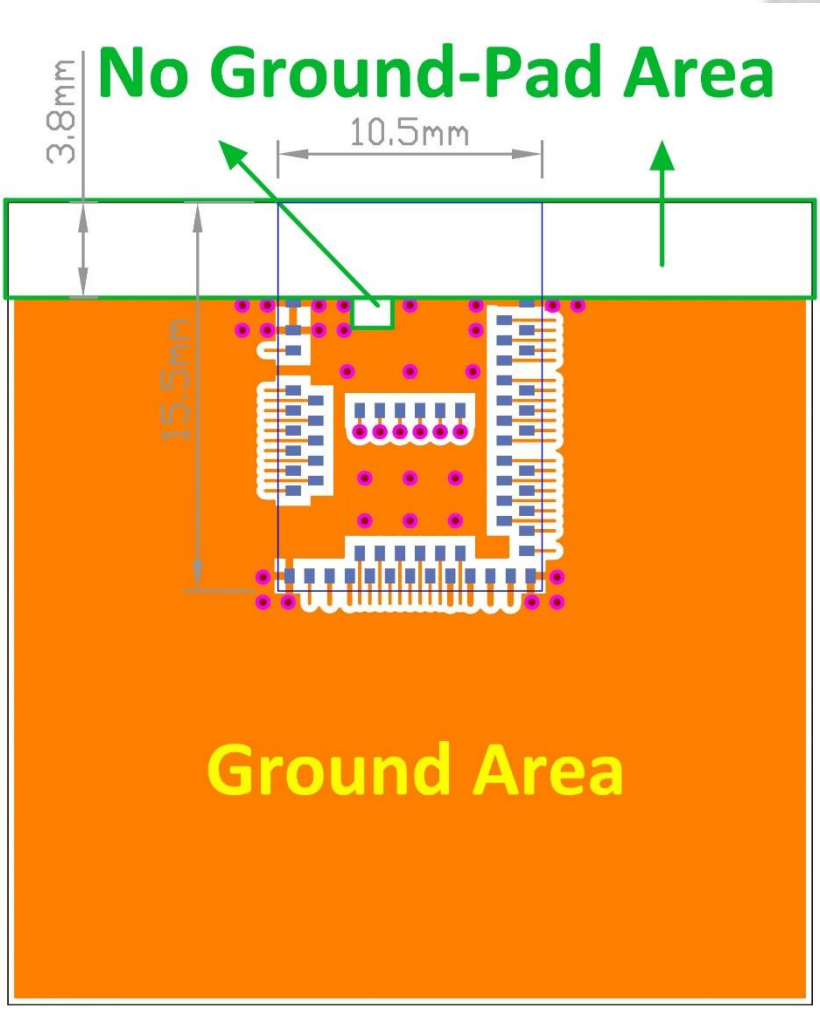
Top View (單位：mm)

recommended solder pad layout

2.3. RF Layout Suggestion (aka Keep-Out Area)

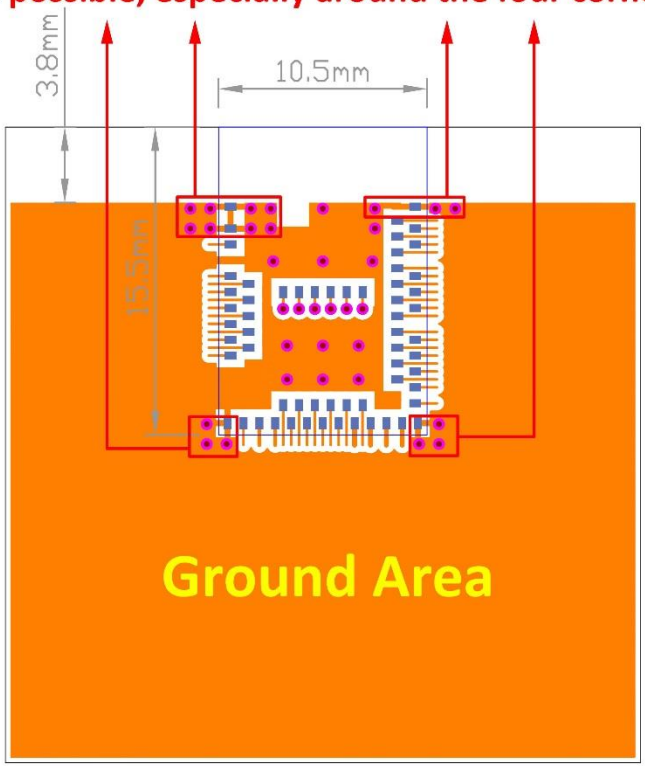
Please follow below instruction to have better wireless performance. Make sure to keep the "No-Ground-Pad" as wider as you can when there is no enough space in your design.

Welcome to send us your layout in PDF for review at service@raytac.com with title "Layout reviewing – MDBT50Q/MDBT50Q-1M/MDBT50Q-P1M/MDBT50Q-U1M – YOUR company's name".

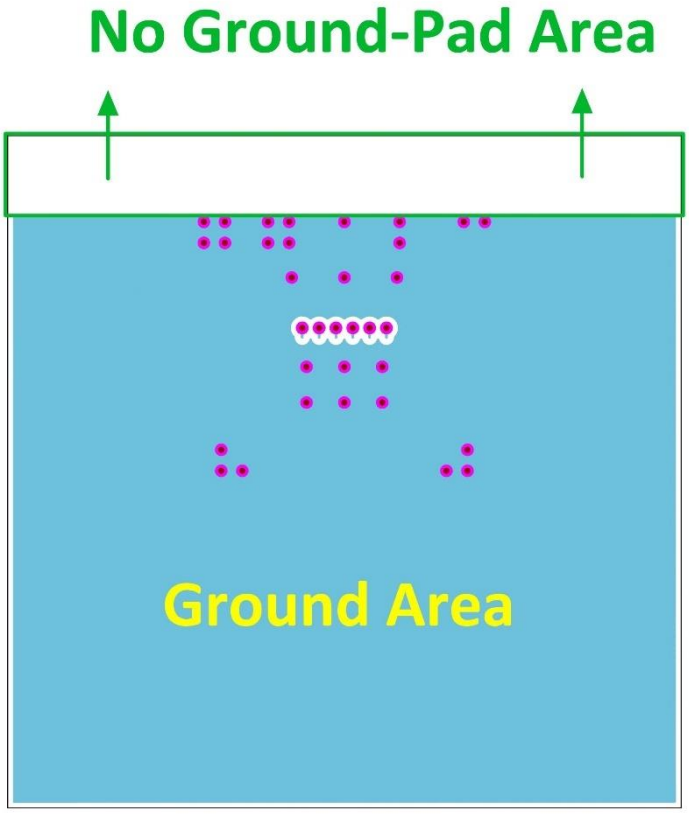


Top layer

Please add via holes in GROUND area as many as possible, especially around the four corners.

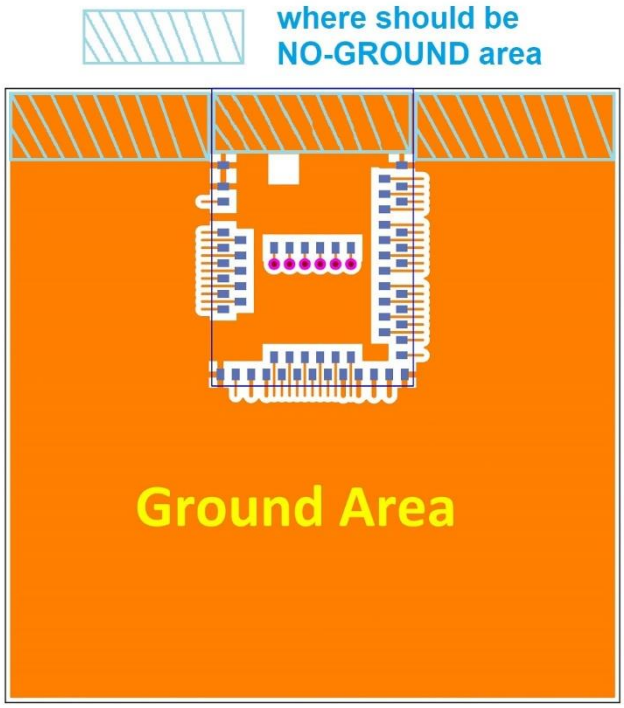


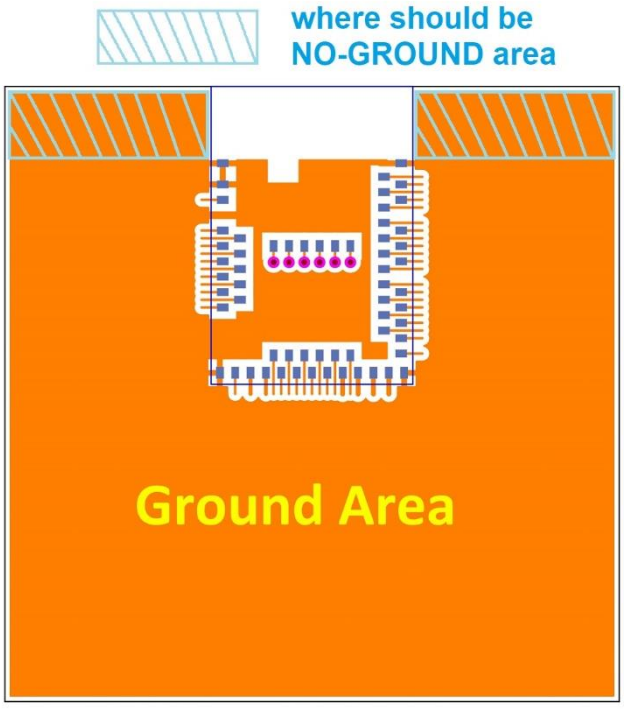
Top layer



Bottom layer

Examples of “**NOT RECOMMENDED**” layout





2.4. Pin Assignment

Pin No.	Name	Pin Function	Description
(1)	GND	Power	Ground
(2)	GND	Power	Ground
(3)	P1.10	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(4)	P1.11	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(5)	P1.12	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(6)	P1.13	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(7)	P1.14	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(8)	P1.15	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(9)	P0.03	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN1	Analog input	Analog input
(10)	P0.29	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN5	Analog input	Analog input
(11)	P0.02	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN0	Analog input	Analog input
(12)	P0.31	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN7	Analog input	Analog input
(13)	P0.28	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN4	Analog input	Analog input

Pin No.	Name	Pin Function	Description
(14)	P0.30	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	AIN6	Analog input	Analog input
(15)	GND	Power	Ground
(16)	P0.27	Digital I/O	General-purpose I/O
(17)	P0.00	Digital I/O	General-purpose I/O
	XL1	Analog input	Connection for 32.768 kHz crystal
(18)	P0.01	Digital I/O	General-purpose I/O
	XL2	Analog input	Connection for 32.768 kHz crystal
(19)	P0.26	Digital I/O	General-purpose I/O
(20)	P0.04	Digital I/O	General-purpose I/O
	AIN2	Analog input	Analog input
(21)	P0.05	Digital I/O	General-purpose I/O
	AIN3	Analog input	Analog input
(22)	P0.06	Digital I/O	General-purpose I/O
(23)	P0.07	Digital I/O	General-purpose I/O
	TRACECLK	Trace clock	Trace buffer clock
(24)	P0.08	Digital I/O	General-purpose I/O
(25)	P1.08	Digital I/O	General-purpose I/O
(26)	P1.09	Digital I/O	General-purpose I/O
	TRACEDATA3	Trace data	Trace buffer TRACEDATA [3].
(27)	P0.11	Digital I/O	General-purpose I/O
	TRACEDATA2	Trace data	Trace buffer TRACEDATA[2].
(28)	VDD	Power	Power supply
(29)	P0.12	Digital I/O	General-purpose I/O
	TRACEDATA1	Trace data	Trace buffer TRACEDATA [1].
(30)	VDDH	Power	High voltage power supply
(31)	DCCH	Power	DC/DC converter output
(32)	VBUS	Power	5V input for USB 3.3V regulator

Pin No.	Name	Pin Function	Description
(33)	GND	Power	Ground
(34)	D–	Digital I/O	USB D-
(35)	D+	Digital I/O	USB D+
(36)	P0.14	Digital I/O	General-purpose digital I/O
(37)	P0.13	Digital I/O	General-purpose digital I/O
(38)	P0.16	Digital I/O	General-purpose digital I/O
(39)	P0.15	Digital I/O	General-purpose digital I/O
(40)	P0.18	Digital I/O	General-purpose digital I/O (recommended usage: QSPI / CSN)
	nRESET		Configurable as system RESET
(41)	P0.17	Digital I/O	General-purpose digital I/O
(42)	P0.19	Digital I/O	General-purpose digital I/O (recommended usage: (QSPI / SCK)
(43)	P0.21	Digital I/O	General-purpose digital I/O (recommended usage: QSPI)
(44)	P0.20	Digital I/O	General-purpose digital I/O
(45)	P0.23	Digital I/O	General-purpose digital I/O (recommended usage: QSPI)
(46)	P0.22	Digital I/O	General-purpose digital I/O (recommended usage: QSPI)
(47)	P1.00	Digital I/O	General-purpose digital I/O (recommended usage: QSPI)
	TRACEDATA0	Trace data	Trace buffer TRACEDATA [0].
(48)	P0.24	Digital I/O	General-purpose digital I/O
(49)	P0.25	Digital I/O	General-purpose digital I/O
(50)	P1.02	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(51)	SWDIO	Debug	Debug serial data
(52)	P0.09	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	NFC1	NFC input	NFC antenna connection
(53)	SWDCLK	Debug	Serial wire debug clock input for debug and programming

Pin No.	Name	Pin function	Description
(54)	P0.10	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
	NFC2	NFC input	NFC antenna connection
(55)	GND	Power	Ground
(56)	P1.04	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(57)	P1.06	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(58)	P1.07	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(59)	P1.05	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(60)	P1.03	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)
(61)	P1.01	Digital I/O	General-purpose I/O (standard drive, low frequency I/O only)

2.5. GPIO Located Near the Radio

Please refer to *2.4 Pin Assignment* on page 16 to 18 where identifies some GPIO that have recommended usage. To maximize RF performance, these GPIO are only available to use under standard drive, low frequency I/O only, wrong usage may lead to undesirable performance.

3. Main Chip Solution

RF IC	Crystal Frequency
Nordic NRF52840	**32MHZ**

32MHz crystal and RF (VDD) DC/DC inductor are already inside the module.

4. Specification

Any technical spec shall refer to Nordic's official documents as final reference.

4.1. Absolute Maximum Ratings

	Note	Min.	Max.	Unit
Supply voltages				
VDD		-0.3	+3.9	V
VDDH		-0.3	+5.8	V
VBUS		-0.3	+5.8	V
VSS			0	V
I/O pin voltage				
$V_{I/O}$, VDD ≤3.6 V		-0.3	VDD + 0.3 V	V
$V_{I/O}$, VDD >3.6 V		-0.3	3.9 V	V
NFC antenna pin current				
$I_{NFC1/2}$			80	mA
Radio				
RF input level			10	dBm
Environmental (aQFN™ package)				
Storage temperature		-40	+125	°C
MSL	Moisture Sensitivity Level		2	
ESD HBM	Human Body Model		2	kV
ESD CDM_{QF}	Charged Device Model (aQFN™ 73, 7×7 mm package)		750	V
Flash memory				
Endurance		10 000		Write/erase cycles
Retention		10 years at 40°C		

4.2. Operating Conditions

Symbol	Parameter	Min.	Nom.	Max.	Units
VDD	VDD supply voltage, independent of DCDC enable	1.7	3.0	3.6	V
VDD_{POR}	VDD supply voltage needed during power-on reset	1.75			V
VDDH	VDDH supply voltage, independent of DCDC enable	2.5	3.7	5.5	V
VBUS	VBUS USB supply voltage	4.35	5	5.5	V
t_{R_VDD}	Supply rise time (0 V to 1.7 V)			60	ms
t_{R_VDDH}	Supply rise time (0 V to 3.7 V)			100	ms
TA	Operating temperature	-40	25	85	°C

*** The on-chip power-on reset circuitry may not function properly for rise times longer than the specified maximum.

4.3. Electrical Specifications

4.3.1. General Radio Characteristics

Symbol	Description	Min.	Typ.	Max.	Units
f_{OP}	Operating frequencies	2360		2500	MHz
$f_{PLL,CH,SP}$	PLL channel spacing		1		MHz
$f_{DELTA,1M}$	Frequency deviation @ 1 Mbps		±170		kHz
$f_{DELTA,BLE,1M}$	Frequency deviation @ BLE 1 Mbps		±250		kHz
$f_{DELTA,2M}$	Frequency deviation @ 2 Mbps		±320		kHz
$f_{DELTA,BLE,2M}$	Frequency deviation @ BLE 2 Mbps		±500		kHz
fsk_{BPS}	On the air data rate	125		2000	kbps
$f_{chip,\ IEEE\ 802.15.4}$	Chip rate in IEEE 802.15.4 mode		2000		kchips

4.3.2. Radio Current Consumption (Transmitter)

Symbol	Description	Min.	Typ.	Max.	Units
$I_{TX,PLUS8dBM,DCDC}$	TX only run current (DC/DC, 3 V) P_{RF} = +8 dBm	..	14.8	..	mA
$I_{TX,PLUS8dBM}$	TX only run current P_{RF} = +8 dBm	..	32.7	..	mA
$I_{TX,PLUS4dBM,DCDC}$	TX only run current (DC/DC, 3 V) P_{RF} = +4 dBm	..	9.6	..	mA
$I_{TX,PLUS4dBM}$	TX only run current P_{RF} = +4 dBm	..	21.4	..	mA
$I_{TX,0dBM,DCDC,5V,REG0HIGH}$	TX only run current (DC/DC, 5 V, REG0 out = 3.3 V)P_{RF} = 0 dBm		3.0		mA
$I_{TX,0dBM,DCDC,5V,REG0L}$	TX only run current (DC/DC, 5 V, REG0 out = 1.8 V)P_{RF} = 0 dBm		3.0		mA
$I_{TX,0dBM,DCDC}$	TX only run current (DC/DC, 3 V)P_{RF} = 0 dBm	..	4.8	8.7	mA
$I_{TX,0dBM}$	TX only run current P_{RF} = 0 dBm	..	10.6	..	mA
$I_{TX,MINUS4dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -4 dBm	..	3.1	..	mA
$I_{TX,MINUS4dBM}$	TX only run current P_{RF} = -4 dBm	..	8.1	..	mA
$I_{TX,MINUS8dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -8 dBm		3.3		mA
$I_{TX,MINUS8dBM}$	TX only run current P_{RF} = -8 dBm	..	7.2	7.9	mA
$I_{TX,MINUS12dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -12 dBm		3.0		mA
$I_{TX,MINUS12dBM}$	TX only run current P_{RF} = -12 dBm	..	6.4	..	mA
$I_{TX,MINUS16dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -16 dBm		2.8		mA
$I_{TX,MINUS16dBM}$	TX only run current P_{RF} = -16 dBm	..	6.0	..	mA
$I_{TX,MINUS20dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -20 dBm		2.7		mA
$I_{TX,MINUS20dBM}$	TX only run current P_{RF} = -20 dBm	..	5.6	..	mA

Symbol	Description	Min.	Typ.	Max.	Units
$I_{TX,MINUS40dBM,DCDC}$	TX only run current DC/DC, 3 V P_{RF} = -40 dBm		2.3		mA
$I_{TX,MINUS40dBM}$	TX only run current P_{RF} = -40 dBm	..	4.6	..	mA
$I_{START,TX,DCDC}$	TX start-up current DC/DC, 3 V, P_{RF} = 4 dBm		5.2		mA
$I_{START,TX}$	TX start-up current, P_{RF} = 4 dBm		11.0		mA

4.3.3. Radio Current Consumption (Receiver)

Symbol	Description	Min.	Typ.	Max.	Units
$I_{RX,1M,DCDC}$	RX only run current (DC/DC, 3 V) 1 Mbps / 1 Mbps BLE	..	4.6	..	mA
$I_{RX,1M}$	RX only run current (LDO, 3 V) 1 Mbps / 1 Mbps BLE	..	9.9	..	mA
$I_{RX,2M,DCDC}$	RX only run current (DC/DC, 3 V) 2 Mbps / 2 Mbps BLE	..	5.2	..	mA
$I_{RX,2M}$	RX only run current (LDO, 3 V) 2 Mbps / 2 Mbps BLE	..	11.1	..	mA
$I_{START,RX,1M,DCDC}$	RX start-up current (DC/DC, 3 V) 1 Mbps / 1 Mbps BLE		3.7		mA
$I_{START,RX,1M}$	RX start-up current 1 Mbps / 1 Mbps BLE		6.7		mA

4.3.4. Transmitter Specification

Symbol	Description	Min.	Typ.	Max.	Units
P_{RF}	Maximum output power	..	8.0	..	dBm
P_{RFC}	RF power control range		28.0		dB
P_{RFCR}	RF power accuracy			±4	dB
$P_{RF1,1}$	1st Adjacent Channel Transmit Power 1 MHz (1 Mbps)	..	-24.8	..	dBc
$P_{RF2,1}$	2nd Adjacent Channel Transmit Power 2 MHz (1 Mbps)	..	-54.0	..	dBc
$P_{RF1,2}$	1st Adjacent Channel Transmit Power 2 MHz (2 Mbps)	..	-25	..	dBc
$P_{RF2,2}$	2nd Adjacent Channel Transmit Power 4 MHz (2 Mbps)	..	-54.0	..	dBc
E_{vm}	Error vector magnitude IEEE 802.15.4	..	8	..	%rms
$P_{harm2nd,\ IEEE\ 802.15.4}$	2nd harmonics in IEEE 802.15.4 mode	..	-51.0	..	dBm
$P_{harm3rd,\ IEEE\ 802.15.4}$	3rd harmonics in IEEE 802.15.4		-48.0	..	dBm

4.3.5. Receiver Operation

Symbol	Description	Min.	Typ.	Max.	Units
$P_{RX,MAX}$	Maximum received signal strength at < 0.1% PER		0		dBm
$P_{SENS,IT,1M}$	Sensitivity, 1 Mbps nRF mode[1]		-93		dBm
$P_{SENS,IT,SP,1M,BLE}$	Sensitivity, 1 Mbps BLE ideal transmitter, <=37 bytes BER=1E-3[2]		-95		dBm
$P_{SENS,IT,LP,1M,BLE}$	Sensitivity, 1 Mbps BLE ideal transmitter >=128 bytes BER=1E-4[3]		-94.0		dBm
$P_{SENS,IT,2M}$	Sensitivity, 2 Mbps nRF mode[4]				dBm
$P_{SENS,IT,SP,2M,BLE}$	Sensitivity, 2 Mbps BLE ideal transmitter, Packet length <=37 bytes		-92		dBm
$P_{SENS,IT,BLE\ LE125k}$	Sensitivity, 125 kbps BLE mode		-103.0		dBm
$P_{SENS,IT,BLE\ LE500k}$	Sensitivity, 500 kbps BLE mode		-99		dBm
$P_{sense,\ IEEE\ 802.15.4}$	Sensitivity in IEEE 802.15.4 mode		-100		dBm

1. Typical sensitivity applies when ADDR0 is used for receiver address correlation. When ADDR [1...7] are used for receiver address correlation, the typical sensitivity for this mode is degraded by 3dB.
2. As defined in the Bluetooth Core Specification v4.0 Volume 6: Core System Package (Low Energy Controller Volume).
3. Equivalent BER limit < 10E-04.
4. Same as remark 1.

4.3.6. RX Selectivity

Symbol	Description	Min.	Typ.	Max.	Units
$C/I_{1M,co\text{-}channel}$	1Mbps mode, Co-Channel interference		9		dB
$C/I_{1M,-1MHz}$	1 Mbps mode, Adjacent (-1 MHz) interference		-2		dB
$C/I_{1M,+1MHz}$	1 Mbps mode, Adjacent (+1 MHz) interference		-10		dB
$C/I_{1M,-2MHz}$	1 Mbps mode, Adjacent (-2 MHz) interference		-19		dB
$C/I_{1M,+2MHz}$	1 Mbps mode, Adjacent (+2 MHz) interference		-42		dB
$C/I_{1M,-3MHz}$	1 Mbps mode, Adjacent (-3 MHz) interference		-38		dB
$C/I_{1M,+3MHz}$	1 Mbps mode, Adjacent (+3 MHz) interference		-48		dB
$C/I_{1M,\pm6MHz}$	1 Mbps mode, Adjacent (≥6 MHz) interference		-50		dB
$C/I_{1MBLE,co\text{-}channel}$	1 Mbps BLE mode, Co-Channel interference		6		dB
$C/I_{1MBLE,-1MHz}$	1 Mbps BLE mode, Adjacent (-1 MHz) interference		-2		dB
$C/I_{1MBLE,+1MHz}$	1 Mbps BLE mode, Adjacent (+1 MHz) interference		-9		dB
$C/I_{1MBLE,-2MHz}$	1 Mbps BLE mode, Adjacent (-2 MHz) interference		-22		dB
$C/I_{1MBLE,+2MHz}$	1 Mbps BLE mode, Adjacent (+2 MHz) interference		-46		dB
$C/I_{1MBLE,>3MHz}$	1 Mbps BLE mode, Adjacent (≥3 MHz) interference		-50		dB
$C/I_{1MBLE,image}$	Image frequency interference		-22		dB
$C/I_{1MBLE,image,1MHz}$	Adjacent (1 MHz) interference to in-band image frequency		-35		dB
$C/I_{2M,co\text{-}channel}$	2 Mbps mode, Co-Channel interference		10		dB

Symbol	Description	Min.	Typ.	Max.	Units
$C/I_{2M,-2MHz}$	2 Mbps mode, Adjacent (-2 MHz) interference		6		dB
$C/I_{2M,+2MHz}$	2 Mbps mode, Adjacent (+2 MHz) interference		-19		dB
$C/I_{2M,-4MHz}$	2 Mbps mode, Adjacent (-4 MHz) interference		-20		dB
$C/I_{2M,+4MHz}$	2 Mbps mode, Adjacent (+4 MHz) interference		-44		dB
$C/I_{2M,-6MHz}$	2 Mbps mode, Adjacent (-6 MHz) interference		-42		dB
$C/I_{2M,+6MHz}$	2 Mbps mode, Adjacent (+6 MHz) interference		-42		dB
$C/I_{2M,\geq12MHz}$	2 Mbps mode, Adjacent (≥12 MHz) interference		-52		dB
$C/I_{2MBLE,co\text{-}channel}$	2 Mbps BLE mode, Co-Channel interference		6.8		dB
$C/I_{2MBLE,\pm2MHz}$	2 Mbps BLE mode, Adjacent (±2 MHz) interference		-10		dB
$C/I_{2MBLE,\pm4MHz}$	2 Mbps BLE mode, Adjacent (±4 MHz) interference		-45		dB
$C/I_{2MBLE,\geq6MHz}$	2 Mbps BLE mode, Adjacent (≥6 MHz) interference		-48		dB
$C/I_{2MBLE,image}$	Image frequency interference		-24		dB
$C/I_{2MBLE,image,\ 2MHz}$	Adjacent (2 MHz) interference to in-band image frequency		-35		dB
$C/I_{125k\ BLE\ LR,\ co\text{-}channel}$	125 kbps BLE LR mode, Co-Channel interference		4.4		dB
$C/I_{125k\ BLE\ LR,-1MHz}$	125 kbps BLE LR mode, Adjacent (-1 MHz) interference		-4.0		dB
$C/I_{125k\ BLE\ LR,+1MHz}$	125 kbps BLE LR mode, Adjacent (+1 MHz) interference		-12		dB
$C/I_{125k\ BLE\ LR,-2MHz}$	125 kbps BLE LR mode, Adjacent (-2 MHz) interference		-28		dB
$C/I_{125k\ BLE\ LR,+2MHz}$	125 kbps BLE LR mode, Adjacent (+2 MHz) interference		-50		dB
$C/I_{125k\ BLE\ LR,>3MHz}$	125 kbps BLE LR mode, Adjacent (≥3 MHz) interference		-55		dB
$C/I_{125k\ BLE\ LR,image}$	Image frequency interference		-29		dB

Remark: Wanted signal level at PIN = -67 dBm. One interferer is used, having equal modulation as the wanted signal. The input power of the interferer where the sensitivity equals BER = 0.1% is presented.

4.3.7. RX Intermodulation

Symbol	Description	Min.	Typ.	Max.	Units
$P_{IMD,5TH,1M}$	IMD performance, 1 Msps, 5th offset channel, Packet length <= 37 bytes		-33		dBm
$P_{IMD,5TH,1M,BLE}$	IMD performance, BLE 1 Msps, 5th offset channel, Packet length <= 37 bytes		-30		dBm
$P_{IMD,5TH,2M}$	IMD performance, 2 Msps, 5th offset channel, Packet length <= 37 bytes		-33		dBm
$P_{IMD,5TH,2M,BLE}$	IMD performance, BLE 2 Msps, 5th offset channel, Packet length <= 37 bytes		-31		dBm

Remark: Wanted signal level at PIN = -64dBm. Two interferers with equal input power are used. The interferer closet in frequency is not modulated, the other interferer is modulated equal with the wanted signal. The input power of the interferers where the sensitivity equals BER = 0.1% is presented.

4.3.8. Radio Timing Parameters

Symbol	Description	Min.	Typ.	Max.	Units
t_{TXEN}	Time between TXEN task and READY event after channel FREQUENCY configured		140		µs
$t_{TXEN,FAST}$	Time between TXEN task and READY event after channel FREQUENCY configured (fast Mode)		40		µs
$t_{TXDISABLE}$	Time between DISABLE task and DISABLED event when the radio was in TX and mode is set to 1Mbps		6		µs
$t_{TXDISABLE,2M}$	Time between DISABLE task and DISABLED event when the radio was in TX and mode is set to 2Mbps		4		µs
t_{RXEN}	Time between the RXEN task and READY event after channel FREQUENCY configured in default mode		140		µs
$t_{RXEN,FAST}$	Time between the RXEN task and READY event after channel FREQUENCY configured in fast mode		40		µs
$t_{RXDISABLE}$	Time between DISABLE task and DISABLED event when the radio was in RX		0		µs
$t_{RX\text{-}to\text{-}TX\ turnaround}$	Maximum TX-to-RX or RX-to-TX turnaround time in IEEE 802.15.4 mode	..	..	..	µs

4.3.9. RSSI Specifications

Symbol	Description	Min.	Typ.	Max.	Units
$RSSI_{ACC}$	RSSI accuracy valid range -90 to -20 dBm		+-2		dB
$RSSI_{RESOLUTION}$	RSSI resolution		1		dB
$RSSI_{PERIOD}$	Sample period		15.0		µs

4.3.10. CPU

Symbol	Description	Min.	Typ.	Max.	Units
W_{FLASH}	CPU wait states, running CoreMark from flash, cache disabled			2	
$W_{FLASHCACHE}$	CPU wait states, running CoreMark from flash, cache enabled			3	
W_{RAM}	CPU wait states, running CoreMark from RAM			0	
CM_{FLASH}	CoreMark, running CoreMark from flash, cache enabled		212		CoreM
$CM_{FLASH/MHz}$	CoreMark per MHz, running CoreMark from flash, cache enabled		3.3		CoreMark/MHz
$CM_{FLASH/mA}$	CoreMark per mA, running CoreMark from flash, cache enabled, DCDC 3V		59		CoreM mA

4.3.11. Power Management

Symbol	Description	Min.	Typ.	Max.	Units
$I_{ON\_RAMOFF\_EVENT}$	System ON, no RAM retention, wake on any event		0.97		µA
$I_{ON\_RAMON\_EVENT}$	System ON, full 256 kB RAM retention, wake on any event		2.35		µA
$I_{ON\_RAMON\_POF}$	System ON, full 256 kB RAM retention, wake on any event, power-fail comparator enabled		2.35		µA
$I_{ON\_RAMON\_GPIOTE}$	System ON, full 256 kB RAM retention, wake on GPIOTE input (event mode)		17.37		µA
$I_{ON\_RAMON\_GPIOTEPORT}$	System ON, full 256 kB RAM retention, wake on GPIOTE PORT event		2.36		µA
$I_{ON\_RAMOFF\_RTC}$	System ON, no RAM retention, wake on RTC (running from LFRC clock)		1.5		µA
$I_{ON\_RAMON\_RTC}$	System ON, full 256 kB RAM retention, wake on RTC (running from LFRC clock)		3.16		µA
$I_{OFF\_RAMOFF\_RESET}$	System OFF, no RAM retention, wake on reset		0.40		µA
$I_{OFF\_RAMOFF\_LPCOMP}$	System OFF, no RAM retention, wake on LPCOMP		0.86		µA
$I_{OFF\_RAMON\_RESET}$	System OFF, full 256 kB RAM retention, wake on reset		1.86		µA
$I_{ON\_RAMOFF\_EVENT\_5V}$	System ON, no RAM retention, wake on any event, 5 V supply on VDDH, REG0 output = 3.3 V		1.29		µA
$I_{OFF\_RAMOFF\_RESET\_5V}$	System OFF, no RAM retention, wake on reset, 5 V supply on VDDH, REG0 output = 3.3 V		0.95		µA

5. FCC Compliance

This equipment has been tested and found to comply with the limits for a Class digital device, pursuant to Part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to the radio communications. However, there are no guarantees that interference will not occur in a particular installation.

Troubleshooting

If this equipment does cause harmful interference to radio reception, which can be determined by turning the equipment off and on, the user is encouraged to correct the interference by one or more of the following instructions.

・Reorient or relocate the receiving antenna.
・Increase the separation between the equipment and receiver.
・Consult dealer or an experienced radio technician.

Conditions

Operation is subject to the following conditions

・This device may not cause harmful interference.
・This device must accept any interference received, including interference that may cause undesired operation.

FCC Caution

This device complies with Part 15 of the FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Any changes or modifications not expressly approved by the party responsible for compliance could void the authority to operate equipment.

RF Exposure

For body worn operation, this device has been tested and meets FCC RF exposure guidelines when used with an accessory that contains no metal and that positions the handset a minimum of 5mm from the body. Use of other accessories may not ensure compliance with FCC RF exposure guidelines.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 5mm may be maintained between the antenna and users. The final end

product must be labeled in a visible area with the following:

Contains FCC ID: SH6MDBT50Q

Manual Information to the End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warming as shown in this manual.

6. IC Caution

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions:

・This device may not cause interference

・This device must accept any interference, including interference that may cause undesired operation of the device

RF exposure

To comply with the FCC RF exposure compliance requirements, this device and its antenna must not be co-located or operating in conjunction with any other antenna or transmitter.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence.L'exploitation est autorisée aux deux conditions suivantes:

・l'appareil ne doit pas produire de brouillage, et

・l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Pour se conformer aux exigences de conformité RF canadienne l'exposition, cet appareil et son antenne ne doivent pas être co-localisés ou fonctionnant en conjonction avec une autre antenne
ou transmetteur.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 5mm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following:

Contains IC ID: 8017A-MDBT50Q

Instructions to OEM Integrators

A User manual provided to the end user must indicate the operating requirements and conditions that must be observed to ensure compliance with the above-mentioned IC RF Exposure guideline. If this module is intended for use in a portable device, integrators are responsible for separate evaluation and/or approval to satisfy IC RF Exposure requirements.

The antenna used this module is as follows;

Antenna Type: u.FL antenna, Chip Antenna, PCB Antenna
Antenna Gain: 5dBi, -0.65dBi, 0.41dBi

7. NCC 警語

根據 NCC 低功率電波輻射性電機管理辦法規定

第十二條：

經型式認證合格之低功率射頻電機，非經許可，公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。

第十四條：

低功率射頻電機之使用不得影響飛航安全及干擾合法通信;經發現有干擾現象時,應立即停用，並改善至無干擾時方得繼續使用。前項合法通信，指依電信法規定作業之無線電通信。

低功率射頻電機須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。

此模組於取得認證後將依規定於模組本體標示審驗合格標籤，並要求平台廠商於平台上標示。

「本產品內含射頻模組：ID 編號 XXXXX」字樣